### 4.5MHz, Single Dual and Quad Precision Rail-to-Rail Input-Output (RRIO) Op Amps with Very Low Input Bias Current

The ISL28148, ISL28248 and ISL28448 are 4.5 MHz low-power single, dual and quad operational amplifiers. The parts are optimized for single supply operation from 2.4 V to 5.5 V , allowing operation from one lithium cell or two $\mathrm{Ni}-\mathrm{Cd}$ batteries.

The single, dual and quad feature an Input Range Enhancement Circuit (IREC) which enables them to maintain CMRR performance for input voltages greater than the positive supply. The input signal is capable of swinging 0.25 V above the positive supply and to 100 mV below the negative supply with only a slight degradation of the CMRR performance. The output operation is rail-to-rail.

The parts draw minimal supply current ( $900 \mu \mathrm{~A}$ per amplifier) while meeting excellent DC accuracy, AC performance, noise and output drive specifications. The ISL28148 features an enable pin that can be used to turn the device off and reduce the supply current to a maximum of $16 \mu \mathrm{~A}$. Operation is guaranteed over $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ temperature range.

## Features

- 4.5 MHz gain bandwidth product
- $900 \mu \mathrm{~A}$ supply current (per amplifier)
- 1.8 mV maximum offset voltage
- 1pA typical input bias current
- Down to 2.4 V single supply operation
- Rail-to-rail input and output
- Enable pin (ISL28148 SOT-23 package only)
- $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ operation
- Pb-free (RoHS compliant)


## Applications

- Low-end audio
- 4 mA to 20 mA current loops
- Medical devices
- Sensor amplifiers
- ADC buffers
- DAC output amplifiers


## Ordering Information

| PART NUMBER (Note) | PART MARKING | PACKAGE (Pb-Free) | PKG. DWG. \# |
| :---: | :---: | :---: | :---: |
| ISL28148FHZ-T7* | GABT (Note 2) | 6 Ld SOT-23 (Tape and Reel) | P6.064A |
| ISL28148FHZ-T7A* | GABT (Note 2) | 6 Ld SOT-23 (Tape and Reel) | P6.064A |
| ISL28248FBZ | 28248 FBZ | 8 Ld SOIC | M8.15E |
| ISL28248FBZ-T7* | 28248 FBZ | 8 Ld SOIC (Tape and Reel) | M8.15E |
| ISL28248FUZ | 82487 | 8 Ld MSOP | M8.118A |
| ISL28248FUZ-T7* | $8248 Z$ | 8 Ld MSOP (Tape and Reel) | M8.118A |
| Coming Soon, ISL28448FVZ | MXZ | 14 Ld TSSOP | M14.173 |
| Coming Soon, ISL28448FVZ-T7* | MXZ | 14 Ld TSSOP (Tape and Reel) | M14.173 |

*Please refer to TB347 for details on reel specifications.
NOTES:

1. These Intersil Pb -free plastic packaged products employ special Pb -free material sets, molding compounds/die attach materials, and $100 \%$ matte tin plate plus anneal (e3 termination finish, which is RoHS compliant and compatible with both SnPb and Pb -free soldering operations). Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb -free requirements of IPC/JEDEC J STD-020.
2. The part marking is located on the bottom of the part.

## Pinouts



ISL28448
(14 LD TSSOP) TOP VIEW


| Absolute Maximum Ratings ( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ ) |  |
| :---: | :---: |
| Supply Voltage . | 5.75 V |
| Supply Turn On Voltage Slew Rate | 1V/us |
| Differential Input Current | 5 mA |
| Differential Input Voltage | 0.5V |
| Input Voltage | V- -0.5V to V+ + 0.5V |
| ESD Rating |  |
| Human Body Model | 3kV |
| Machine Model. | . 300 V |
| Charged Device Model. | 1200 V |

## Thermal Information

| Thermal Resistance (Typical, Note 3) | $\theta_{\text {JA }}\left({ }^{\circ} \mathrm{C} / \mathrm{W}\right)$ |
| :---: | :---: |
| 6 Ld SOT-23 Package | 230 |
| 8 Ld SO Package. | 125 |
| 8 Ld MSOP Package | 175 |
| 14 Ld TSSOP Package | 115 |
| Ambient Operating Temperature Range | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Operating Junction Temperature | $+125^{\circ} \mathrm{C}$ |
| Pb-free Reflow Profile . . . . . . . . . . . . http://www.intersil.com/pbfree/Pb-Fr | .see link below |

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.
NOTE:
3. $\theta_{\mathrm{JA}}$ is measured with the component mounted on a high effective thermal conductivity test board in free air. See Tech Brief TB379 for details.

> IMPORTANT NOTE: All parameters having Min/Max specifications are guaranteed. Typical values are for information purposes only. Unless otherwise noted, all tests are at the specified temperature and are pulsed tests, therefore: $T_{J}=T_{C}=T_{A}$

Electrical Specifications $\quad \mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{CM}}=2.5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=\mathrm{Open}, \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise specified.
Boldface limits apply over the operating temperature range, $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. Temperature data established by characterization.

| PARAMETER | DESCRIPTION | CONDITIONS | $\begin{gathered} \text { MIN } \\ \text { (Note 4) } \end{gathered}$ | TYP | $\begin{array}{\|c\|} \text { MAX } \\ \text { (Note 4) } \end{array}$ | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| V ${ }_{\text {OS }}$ | Input Offset Voltage | ISL28148 | $\begin{gathered} \hline-1.8 \\ -2 \end{gathered}$ | 0 | $\begin{gathered} 1.8 \\ 2 \end{gathered}$ | mV |
|  |  | ISL28248 and ISL28448 | $\begin{aligned} & -1.8 \\ & -2.8 \end{aligned}$ | 0 | $\begin{aligned} & 1.8 \\ & 2.8 \end{aligned}$ | mV |
| $\frac{\Delta \mathrm{V}_{\mathrm{OS}}}{\Delta \mathrm{~T}}$ | Input Offset Voltage vs Temperature |  |  | 0.03 |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| los | Input Offset Current | $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\begin{aligned} & -35 \\ & -80 \end{aligned}$ | $\pm 5$ | $\begin{aligned} & 35 \\ & 80 \end{aligned}$ | pA |
| $\mathrm{I}_{\mathrm{B}}$ | Input Bias Current | $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $\begin{aligned} & -30 \\ & -80 \end{aligned}$ | $\pm 1$ | $\begin{aligned} & 30 \\ & 80 \end{aligned}$ | pA |
| CMIR | Common-Mode Voltage Range | Guaranteed by CMRR | 0 |  | 5 | V |
| CMRR | Common-Mode Rejection Ratio | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ to 5 V | $\begin{aligned} & 75 \\ & 70 \end{aligned}$ | 98 |  | dB |
| PSRR | Power Supply Rejection Ratio | $\mathrm{V}_{+}=2.4 \mathrm{~V}$ to 5.5 V | $\begin{aligned} & 80 \\ & 75 \end{aligned}$ | 98 |  | dB |
| AVOL | Large Signal Voltage Gain | $\mathrm{V}_{\mathrm{O}}=0.5 \mathrm{~V}$ to $4.5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=100 \mathrm{k} \Omega$ to $\mathrm{V}_{\mathrm{CM}}$ | $\begin{aligned} & 200 \\ & 150 \end{aligned}$ | 580 |  | V/mV |
|  |  | $\mathrm{V}_{\mathrm{O}}=0.5 \mathrm{~V}$ to $4.5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega$ to $\mathrm{V}_{\mathrm{CM}}$ |  | 50 |  | V/mV |
| V OUT | Maximum Output Voltage Swing | Output low, $\mathrm{R}_{\mathrm{L}}=100 \mathrm{k} \Omega$ to $\mathrm{V}_{\mathrm{CM}}$ |  | 3 | $\begin{aligned} & 6 \\ & 8 \end{aligned}$ | mV |
|  |  | Output low, $\mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega$ to $\mathrm{V}_{\mathrm{CM}}$ |  | 50 | $\begin{gathered} \hline 70 \\ 110 \end{gathered}$ | mV |
|  |  | Output high, $\mathrm{R}_{\mathrm{L}}=100 \mathrm{k} \Omega$ to $\mathrm{V}_{\mathrm{CM}}$ | $\begin{gathered} 4.994 \\ 4.99 \end{gathered}$ | 4.998 |  | V |
|  |  | Output high, $\mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega$ to $\mathrm{V}_{\mathrm{CM}}$ | $\begin{aligned} & 4.93 \\ & 4.89 \end{aligned}$ | 4.95 |  | V |
| $\mathrm{I}_{\mathrm{S}, \mathrm{ON}}$ | Quiescent Supply Current, Enabled | Per Amplifier |  | 0.9 | $\begin{gathered} 1.25 \\ 1.4 \end{gathered}$ | mA |
| IS,OFF | Quiescent Supply Current, Disabled | ISL28148 SOT-23 package only |  | 10 | $\begin{aligned} & 14 \\ & 16 \end{aligned}$ | $\mu \mathrm{A}$ |
| $\mathrm{l}^{+}$ | Short-Circuit Output Source Current | $\mathrm{R}_{\mathrm{L}}=10 \Omega$ to $\mathrm{V}_{\mathrm{CM}}$ | $\begin{aligned} & 48 \\ & 45 \end{aligned}$ | 75 |  | mA |

Electrical Specifications $\mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{CM}}=2.5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=\mathrm{Open}, \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise specified.
Boldface limits apply over the operating temperature range, $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. Temperature data established by characterization. (Continued)

| PARAMETER | DESCRIPTION | CONDITIONS | $\begin{gathered} \text { MIN } \\ \text { (Note 4) } \end{gathered}$ | TYP | MAX (Note 4) | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{I}^{-}$ | Short-Circuit Output Sink Current | $\mathrm{R}_{\mathrm{L}}=10 \Omega$ to $\mathrm{V}_{\mathrm{CM}}$ |  | -68 | $\begin{aligned} & \hline-48 \\ & -45 \end{aligned}$ | mA |
| V SUPPLY | Supply Operating Range | V+ to V- | 2.4 |  | 5.5 | V |
| $\mathrm{V}_{\text {ENH }}$ | $\overline{\mathrm{EN}}$ Pin High Level | ISL28148 SOT-23 package only | 2 |  |  | V |
| $\mathrm{V}_{\text {ENL }}$ | $\overline{\text { EN }}$ Pin Low Level | ISL28148 SOT-23 package only |  |  | 0.8 | V |
| IENH | $\overline{\mathrm{EN}}$ Pin Input High Current | $V_{\overline{E N}}=\mathrm{V}+$, ISL28148 SOT-23 package only |  | 1 | $\begin{aligned} & 1.5 \\ & 1.6 \end{aligned}$ | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {ENL }}$ | $\overline{\mathrm{EN}}$ Pin Input Low Current | $\mathrm{V}_{\mathrm{EN}}=\mathrm{V}$-, ISL28148 SOT-23 package only |  | 12 | $\begin{aligned} & 25 \\ & 30 \end{aligned}$ | nA |
| AC SPECIFICATIONS |  |  |  |  |  |  |
| GBW | Gain Bandwidth Product | $\begin{aligned} & A_{V}=100, R_{F}=100 \mathrm{k} \Omega, R_{G}=1 \mathrm{k} \Omega, \\ & R_{L}=10 \mathrm{k} \Omega \text { to } V_{C M} \end{aligned}$ |  | 4.5 |  | MHz |
| Unity Gain Bandwidth | -3dB Bandwidth | $\begin{aligned} & A_{V}=1, R_{F}=0 \Omega, V_{\text {OUT }}=10 \mathrm{mV}_{\mathrm{P}-\mathrm{P},} \\ & \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \text { to } \mathrm{V}_{\mathrm{CM}} \end{aligned}$ |  | 13 |  | MHz |
| $\mathrm{e}_{\mathrm{N}}$ | Input Noise Voltage Peak-to-Peak | $\mathrm{f}=0.1 \mathrm{~Hz}$ to 10 Hz |  | 2 |  | $\mu \mathrm{VPP}$ |
|  | Input Noise Voltage Density | $\mathrm{f}_{\mathrm{O}}=1 \mathrm{kHz}$ |  | 28 |  | $\mathrm{nV} / \sqrt{ } \mathrm{Hz}$ |
| $\mathrm{i}_{\mathrm{N}}$ | Input Noise Current Density | $\mathrm{f}_{\mathrm{O}}=1 \mathrm{kHz}$ |  | 0.016 |  | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |
| CMRR @ 60Hz | Input Common Mode Rejection Ratio | $\mathrm{V}_{\mathrm{CM}}=1 \mathrm{~V}_{\mathrm{P}-\mathrm{P},} \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ to $\mathrm{V}_{\mathrm{CM}}$ |  | 85 |  | dB |
| $\begin{aligned} & \hline \text { PSRR- @ } \\ & 120 \mathrm{~Hz} \end{aligned}$ | Power Supply Rejection Ratio (V.) | $\begin{aligned} & \mathrm{V}_{+}, \mathrm{V}_{-}= \pm 1.2 \mathrm{~V} \text { and } \pm 2.5 \mathrm{~V}, \\ & \mathrm{~V}_{\text {SOURCE }}=1 \mathrm{~V}_{\mathrm{P}-\mathrm{P},} \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \text { to } \mathrm{V}_{\mathrm{CM}} \end{aligned}$ |  | -82 |  | dB |
| $\begin{aligned} & \text { PSRR+ @ } \\ & 120 \mathrm{~Hz} \end{aligned}$ | Power Supply Rejection Ratio ( $\mathrm{V}_{+}$) | $\begin{aligned} & \mathrm{V}_{+}, \mathrm{V}_{-}= \pm 1.2 \mathrm{~V} \text { and } \pm 2.5 \mathrm{~V} \\ & \mathrm{~V}_{\text {SOURCE }}=1 \mathrm{~V}_{\mathrm{P}-\mathrm{P},} \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \text { to } \mathrm{V}_{\mathrm{CM}} \end{aligned}$ |  | -100 |  | dB |
| TRANSIENT RESPONSE |  |  |  |  |  |  |
| SR | Slew Rate |  |  | $\pm 4$ |  | V/ $/ \mathrm{s}$ |
| $\mathrm{t}_{\mathrm{r},} \mathrm{t}_{\mathrm{f}}$, Large Signal | Rise Time, $10 \%$ to $90 \%$, $\mathrm{V}_{\text {OUT }}$ | $\begin{aligned} & \mathrm{A}_{\mathrm{V}}=+2, \mathrm{~V}_{\mathrm{OUT}}=3 \mathrm{~V}_{\mathrm{P}-\mathrm{P},} \mathrm{R}_{\mathrm{G}}=\mathrm{R}_{\mathrm{F}}=10 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \text { to } \mathrm{V}_{\mathrm{CM}} \end{aligned}$ |  | 530 |  | ns |
|  | Fall Time, $90 \%$ to 10\%, V ${ }_{\text {OUT }}$ | $\begin{aligned} & \mathrm{A}_{\mathrm{V}}=+2, \mathrm{~V}_{\mathrm{OUT}}=3 \mathrm{~V}_{\mathrm{P}-\mathrm{P},} \mathrm{R}_{\mathrm{G}}=\mathrm{R}_{\mathrm{F}}=10 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \text { to } \mathrm{V}_{\mathrm{CM}} \end{aligned}$ |  | 530 |  | ns |
| $\mathrm{t}_{\mathrm{r}}, \mathrm{t}_{\mathrm{f}}$, Small Signal | Rise Time, $10 \%$ to $90 \%$, V ${ }_{\text {OUT }}$ | $\begin{aligned} & A_{V}=+2, V_{O U T}=10 \mathrm{~m} V_{P-P,} \\ & R_{G}=R_{F}=R_{L}=10 k \Omega \text { to } V_{C M} \end{aligned}$ |  | 50 |  | ns |
|  | Fall Time, $90 \%$ to 10\%, V ${ }_{\text {OUT }}$ | $\begin{aligned} & A_{V}=+2, V_{O U T}=10 \mathrm{mV}_{P-P,} \\ & R_{G}=R_{F}=R_{L}=10 \mathrm{k} \Omega \text { to } V_{C M} \end{aligned}$ |  | 50 |  | ns |
| ${ }^{\text {teN }}$ | Enable to Output Turn-on Delay Time, 10\% $\overline{\mathrm{EN}}$ to $10 \% \mathrm{~V}_{\text {OUT }}$, (ISL28148) | $\begin{aligned} & \overline{E N}=5 \mathrm{~V} \text { to } 0 \mathrm{~V}, \mathrm{~A}_{\mathrm{V}}=+2, \\ & \mathrm{R}_{\mathrm{G}}=\mathrm{R}_{\mathrm{F}}=\mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \text { to } \mathrm{V}_{\mathrm{CM}} \end{aligned}$ |  | 5 |  | $\mu \mathrm{s}$ |
|  | Enable to Output Turn-off Delay Time, 10\% $\overline{\mathrm{EN}}$ to $10 \% \mathrm{~V}_{\mathrm{OUT}}$, (ISL28148) | $\begin{aligned} & V_{\overline{E N}}=0 \mathrm{~V} \text { to } 5 \mathrm{~V}, \mathrm{~A}_{\mathrm{V}}=+2, \\ & \mathrm{R}_{\mathrm{G}}=\mathrm{R}_{\mathrm{F}}=\mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \text { to } \mathrm{V}_{\mathrm{CM}} \end{aligned}$ |  | 0.2 |  | $\mu \mathrm{s}$ |

## NOTE:

4. Parameters with MIN and/or MAX limits are $100 \%$ tested at $+25^{\circ} \mathrm{C}$, unless otherwise specified. Temperature limits established by characterization and are not production tested.

Typical Performance Curves $\mathrm{v}+=5 \mathrm{~V}, \mathrm{v}=0 \mathrm{~V}, \mathrm{v}_{\mathrm{CM}}=2.5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=\mathrm{Open}$


FIGURE 1. GAIN vs FREQUENCY vs FEEDBACK RESISTOR VALUES $\mathbf{R}_{\mathrm{f}} / \mathbf{R}_{\mathbf{g}}$


FIGURE 3. GAIN vs FREQUENCY vs $\mathrm{V}_{\mathrm{OUT}}, \mathrm{R}_{\mathrm{L}}=10 \mathrm{k}$


FIGURE 5. GAIN vs FREQUENCY vs $\mathrm{R}_{\mathrm{L}}$


FIGURE 2. GAIN vs FREQUENCY vs $\mathrm{V}_{\mathrm{OUT}}, \mathrm{R}_{\mathrm{L}}=\mathbf{1 k}$


FIGURE 4. GAIN vs FREQUENCY vs $\mathrm{V}_{\mathrm{OUT}}$, $\mathrm{R}_{\mathrm{L}}=100 \mathrm{k}$


FIGURE 6. FREQUENCY RESPONSE vs CLOSED LOOP GAIN

Typical Performance Curves $\mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{CM}}=2.5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=\mathrm{Open}$ (Continued)


FIGURE 7. GAIN vs FREQUENCY vs SUPPLY VOLTAGE


FIGURE 9. CMRR vs FREQUENCY; $\mathrm{V}_{+}=2.4 \mathrm{~V}$ AND 5V


FIGURE 11. PSRR vs FREQUENCY $V_{+}, V_{-}= \pm 2.5 \mathrm{~V}$


FIGURE 8. GAIN vs FREQUENCY vs $\mathrm{C}_{\mathrm{L}}$


FIGURE 10. PSRR vs FREQUENCY, $\mathrm{V}_{\mathbf{+}}, \mathrm{V}_{\mathbf{-}}= \pm 1.2 \mathrm{~V}$


FIGURE 12. INPUT VOLTAGE NOISE DENSITY vs FREQUENCY

Typical Performance Curves $\mathrm{V}+=5 \mathrm{~V}, \mathrm{v}-=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{CM}}=2.5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=$ Open (Continued)


FIGURE 13. INPUT CURRENT NOISE DENSITY vs FREQUENCY


FIGURE 15. LARGE SIGNAL STEP RESPONSE


FIGURE 14. INPUT VOLTAGE NOISE 0.1 Hz TO 10 Hz


FIGURE 16. SMALL SIGNAL STEP RESPONSE


FIGURE 17. ISL28148 ENABLE TO OUTPUT RESPONSE

Typical Performance Curves $\mathrm{v}+=5 \mathrm{~V}, \mathrm{~V}_{-}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{CM}}=2.5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=$ Open (Continued)


FIGURE 18. INPUT OFFSET VOLTAGE vs COMMON MODE INPUT VOLTAGE


FIGURE 20. SUPPLY CURRENT ENABLED vs TEMPERATURE $\mathrm{V}_{+}, \mathrm{V}_{-}= \pm 2.5 \mathrm{~V}$


FIGURE 22. $\mathrm{V}_{\mathrm{OS}} \mathrm{vs}$ TEMPERATURE $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}, \mathrm{~V}_{+}, \mathrm{V}_{-}= \pm 2.75 \mathrm{~V}$


FIGURE 19. INPUT BIAS CURRENT vs COMMON MODE INPUT VOLTAGE


FIGURE 21. SUPPLY CURRENT DISABLED vs TEMPERATURE $\mathrm{V}_{+}, \mathrm{V}_{-}= \pm 2.5 \mathrm{~V}$


FIGURE 23. $\mathrm{V}_{\mathrm{OS}}$ vs TEMPERATURE $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}, \mathrm{~V}_{\mathbf{+}}, \mathrm{V}_{-}= \pm 2.5 \mathrm{~V}$

Typical Performance Curves $\mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}-=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{CM}}=2.5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=\mathrm{Open}$ (Continued)


FIGURE 24. $\mathrm{V}_{\mathrm{OS}}$ vs TEMPERATURE $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}, \mathrm{~V}_{+}, \mathrm{V}_{-}= \pm 1.2 \mathrm{~V}$


FIGURE 26. $\mathrm{I}_{\mathrm{BIAS}}-\mathrm{vs}$ TEMPERATURE $\mathrm{V}_{+}, \mathrm{V}_{-}= \pm 1.2 \mathrm{~V}$


FIGURE 28. $\mathrm{l}_{\mathrm{OS}}$ vs TEMPERATURE $\mathrm{V}_{+}, \mathrm{V}_{-}= \pm \mathbf{1 . 2 \mathrm { V }}$


FIGURE 25. $\mathrm{I}_{\mathrm{BIAS}}{ }^{-}$vs TEMPERATURE $\mathrm{V}_{+}, \mathrm{V}_{-}= \pm 2.5 \mathrm{~V}$


FIGURE 27. $\mathrm{I}_{\mathrm{OS}}$ vs TEMPERATURE $\mathrm{V}_{\mathbf{+}}, \mathrm{V}_{\mathbf{-}}= \pm 2.5 \mathrm{~V}$


FIGURE 29. $A_{\text {VOL }}$ vs TEMPERATURE $R_{L}=100 k, V_{+}, V_{-}= \pm 2.5 \mathrm{~V}$, $V_{O}=-2 V T O+2 V$

Typical Performance Curves $\mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}_{-}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{CM}}=2.5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=$ Open (Continued)


FIGURE 30. $A_{\text {VOL }}$ vs TEMPERATURE $R_{L}=1 \mathrm{k}, \mathrm{V}_{+}, \mathrm{V}_{\mathbf{-}}= \pm 2.5 \mathrm{~V}$, $\mathrm{V}_{\mathrm{O}}=-2 \mathrm{~V}$ TO +2 V


FIGURE 32. PSRR vs TEMPERATURE $\mathrm{V}_{+}, \mathrm{V}_{-}= \pm 1.2 \mathrm{~V}$ TO $\pm 2.75 \mathrm{~V}$


FIGURE 34. $\mathrm{V}_{\text {OUT }}$ HIGH vs TEMPERATURE $\mathrm{R}_{\mathrm{L}}=100 \mathrm{k}$, $\mathrm{V}_{+}, \mathrm{V}_{-}= \pm 2.5 \mathrm{~V}$


FIGURE 31. CMRR vs TEMPERATURE $\mathrm{V}_{\mathrm{CM}}=-2.5 \mathrm{~V}$ TO +2.5V, $\mathrm{V}_{+}, \mathrm{V}_{-}= \pm 2.5 \mathrm{~V}$


FIGURE 33. $\mathrm{V}_{\text {OUT }}$ HIGH vs TEMPERATURE $R_{L}=1 \mathrm{k}$, $\mathrm{V}_{+}, \mathrm{V}_{-}= \pm 2.5 \mathrm{~V}$


FIGURE 35. $\mathrm{V}_{\text {OUT }}$ LOW vs TEMPERATURE $R_{\mathrm{L}}=1 \mathrm{k}$,
$\mathrm{V}_{+}, \mathrm{V}_{-}= \pm 2.5 \mathrm{~V}$

Typical Performance Curves $\mathrm{V}+=5 \mathrm{~V}, \mathrm{~V}_{-}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{CM}}=2.5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=$ Open (Continued)


FIGURE 36. $\mathrm{V}_{\text {OUT }}$ LOW vs TEMPERATURE $\mathrm{R}_{\mathrm{L}}=100 \mathrm{k}$, $\mathrm{V}_{+}, \mathrm{V}_{-}= \pm 2.5 \mathrm{~V}$


FIGURE 37. + OUTPUT SHORT CIRCUIT CURRENT vs TEMPERATURE $\mathrm{V}_{\mathrm{IN}}=2.55 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=10$, $\mathrm{V}_{+}, \mathrm{V}_{-}= \pm 2.5 \mathrm{~V}$


FIGURE 38. - OUTPUT SHORT CIRCUIT CURRENT vs TEMPERATURE $V_{I N}=-2.55 \mathrm{~V}, R_{\mathrm{L}}=10, \mathrm{~V}_{\mathbf{+}}, \mathrm{V}_{\mathbf{-}}= \pm 2.5 \mathrm{~V}$

Pin Descriptions

| $\begin{gathered} \text { ISL28148 } \\ \text { (6 Ld SOT-23) } \end{gathered}$ | $\begin{aligned} & \text { ISL28248 } \\ & \text { (8 Ld SO) } \\ & \text { (8 Ld MSOP) } \end{aligned}$ | $\begin{gathered} \text { ISL28448 } \\ \text { (14 Ld TSSOP) } \end{gathered}$ | PIN NAME | FUNCTION | EQUIVALENT CIRCUIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 4 | $\begin{aligned} & 2 \text { (A) } \\ & 6 \text { (B) } \end{aligned}$ | $\begin{aligned} & 2 \text { (A) } \\ & 6 \text { (B) } \\ & 9 \text { (C) } \\ & 13 \text { (D) } \end{aligned}$ | $\begin{aligned} & \text { IN- } \\ & \text { IN-_A } \\ & \text { IN-_B } \\ & \text { IN-_C } \\ & \text { IN-_D } \end{aligned}$ | inverting input |  |
| 3 | $\begin{aligned} & 3 \text { (A) } \\ & 5 \text { (B) } \end{aligned}$ | $\begin{gathered} 3 \text { (A) } \\ 5 \text { (B) } \\ 10 \text { (C) } \\ 12 \text { (D) } \end{gathered}$ | $\begin{aligned} & \text { IN+ } \\ & \text { IN }+ \text { _A } \\ & \text { IN+_B } \\ & \text { IN+_C } \\ & \text { IN+_D } \end{aligned}$ | Non-inverting input | (See circuit 1) |

## Pin Descriptions (Continued)

| $\begin{gathered} \text { ISL28148 } \\ \text { (6 Ld SOT-23) } \end{gathered}$ | $\begin{aligned} & \text { ISL28248 } \\ & \text { (8 Ld SO) } \\ & \text { (8 Ld MSOP) } \end{aligned}$ | $\begin{gathered} \text { ISL28448 } \\ \text { (14 Ld TSSOP) } \end{gathered}$ | PIN NAME | FUNCTION | EQUIVALENT CIRCUIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 2 | 4 | 11 | V- | Negative supply |  |
| 1 | $\begin{aligned} & 1 \text { (A) } \\ & 7 \text { (B) } \end{aligned}$ | $\begin{gathered} 1 \text { (A) } \\ 7 \text { (B) } \\ 8 \text { (C) } \\ 14 \text { (D) } \end{gathered}$ | OUT <br> OUT_A <br> OUT_B <br> OUT_C <br> OUT_D | Output |  |
| 6 | 8 | 4 | V+ | Positive supply | (See circuit 2) |
| 5 |  | - | EN | Chip enable |  |

## Applications Information

## Introduction

The ISL28148, ISL28248 and ISL28448 are single, dual and quad channel CMOS rail-to-rail input, output (RRIO) micropower precision operational amplifiers. The parts are designed to operate from single supply ( 2.4 V to 5.5 V ) or dual supply ( $\pm 1.2 \mathrm{~V}$ to $\pm 2.75 \mathrm{~V}$ ). The parts have an input common mode range that extends 0.25 V above the positive rail and 100 mV below the negative supply rail. The output can swing within about 3 mV of the supply rails with a $100 \mathrm{k} \Omega$ load.

## Rail-to-Rail Input

Many rail-to-rail input stages use two differential input pairs, a long-tail PNP (or PFET) and an NPN (or NFET). Severe penalties have to be paid for this circuit topology. As the input signal moves from one supply rail to another, the operational amplifier switches from one input pair to the other causing drastic changes in input offset voltage and an undesired change in magnitude and polarity of input offset current.

The parts achieve input rail-to-rail operation without sacrificing important precision specifications and degrading distortion performance. The devices' input offset voltage exhibits a smooth behavior throughout the entire common-mode input range. The input bias current vs the common-mode voltage range gives us an undistorted
behavior from typically 100 mV below the negative rail and 0.25 V higher than the $\mathrm{V}+$ rail.

## Rail-to-Rail Output

A pair of complementary MOS devices are used to achieve the rail-to-rail output swing. The NMOS sinks current to swing the output in the negative direction. The PMOS sources current to swing the output in the positive direction. The devices' with a $100 \mathrm{k} \Omega$ load will swing to within 3 mV of the positive supply rail and within 3 mV of the negative supply rail.

## Results of Overdriving the Output

Caution should be used when overdriving the output for long periods of time. Overdriving the output can occur in two ways:

1. The input voltage times the gain of the amplifier exceeds the supply voltage by a large value or
2. The output current required is higher than the output stage can deliver. These conditions can result in a shift in the Input Offset Voltage ( $\mathrm{V}_{\mathrm{OS}}$ ) as much as $1 \mu \mathrm{~V} / \mathrm{hr}$. of exposure under these condition.

## IN+ and IN- Input Protection

All input terminals have internal ESD protection diodes to both positive and negative supply rails, limiting the input voltage to within one diode beyond the supply rails. They also contain back-to-back diodes across the input terminals ("Pin Descriptions" table - Circuit 1 on page 11). For applications where the input differential voltage is expected to exceed
0.5 V , an external series resistor must be used to ensure the input currents never exceed 5mA (Figure 39).


FIGURE 39. INPUT CURRENT LIMITING

## Enable/Disable Feature

The ISL28148 offers an $\overline{\mathrm{EN}}$ pin that disables the device when pulled up to at least 2.0 V . In the disabled state (output in a high impedance state), the part consumes typically $10 \mu \mathrm{~A}$ at room temperature. By disabling the part, multiple ISL28148 parts can be connected together as a MUX. In this configuration, the outputs are tied together in parallel and a channel can be selected by the $\overline{\mathrm{EN}}$ pin. The loading effects of the feedback resistors of the disabled amplifier must be considered when multiple amplifier outputs are connected together. Note that feed-through from the IN+ to IN- pins occurs on any Mux Amp disabled channel where the input differential voltage exceeds 0.5 V (e.g., active channel $\mathrm{V}_{\text {OUT }}=1 \mathrm{~V}$, while disabled channel $\mathrm{V}_{\text {IN }}=\mathrm{GND}$ ), so the mux implementation is best suited for small signal applications. If large signals are required, use series $\mathrm{IN}+$ resistors, or large value $R_{F}$, to keep the feed-through current low enough to minimize the impact on the active channel. See "Limitations of the Differential Input Protection" on page 13 for more details. The $\overline{\mathrm{EN}}$ pin also has an internal pull-down. If left open, the $\overline{E N}$ pin will pull to the negative rail and the device will be enabled by default. When not used, the $\overline{\mathrm{EN}}$ pin should either be left floating or connected directly to the $V$ - pin.

## Limitations of the Differential Input Protection

If the input differential voltage is expected to exceed 0.5 V , an external current limiting resistor must be used to ensure the input current never exceeds 5 mA . For non-inverting unity gain applications the current limiting can be via a series $\mathrm{IN}+$ resistor, or via a feedback resistor of appropriate value. For other gain configurations, the series $\mathrm{IN}+$ resistor is the best choice, unless the feedback $\left(R_{F}\right)$ and gain setting $\left(R_{G}\right)$ resistors are both sufficiently large to limit the input current to 5 mA .
Large differential input voltages can arise from several sources:

- During open loop (comparator) operation. Used this way, the $\mathrm{IN}+$ and IN - voltages don't track, so differentials arise.
- When the amplifier is disabled but an input signal is still present. An $R_{L}$ or $R_{G}$ to GND keeps the IN- at GND, while the varying $\mathrm{IN}+$ signal creates a differential voltage. Mux Amp applications are similar, except that the active channel $\mathrm{V}_{\text {OUT }}$ determines the voltage on the IN - terminal.
- When the slew rate of the input pulse is considerably faster than the op amp's slew rate. If the $\mathrm{V}_{\mathrm{OUT}}$ can't keep up with the IN+ signal, a differential voltage results, and
visible distortion occurs on the input and output signals. To avoid this issue, keep the input slew rate below $4.8 \mathrm{~V} / \mu \mathrm{s}$, or use appropriate current limiting resistors.
Large ( $>2 \mathrm{~V}$ ) differential input voltages can also cause an increase in disabled $\mathrm{I}_{\mathrm{CC}}$.


## Using Only One Channel

If the application does not use all channels, then the user must configure the unused channel(s) to prevent them from oscillating. The unused channel(s) will oscillate if the input and output pins are floating. This will result in higher than expected supply currents and possible noise injection into the channel being used. The proper way to prevent this oscillation is to short the output to the negative input and ground the positive input (as shown in Figure 40).


FIGURE 40. PREVENTING OSCILLATIONS IN UNUSED CHANNELS

## Proper Layout Maximizes Performance

To achieve the maximum performance of the high input impedance and low offset voltage, care should be taken in the circuit board layout. The PC board surface must remain clean and free of moisture to avoid leakage currents between adjacent traces. Surface coating of the circuit board will reduce surface moisture and provide a humidity barrier, reducing parasitic resistance on the board. When input leakage current is a concern, the use of guard rings around the amplifier inputs will further reduce leakage currents. Figure 41 shows a guard ring example for a unity gain amplifier that uses the low impedance amplifier output at the same voltage as the high impedance input to eliminate surface leakage. The guard ring does not need to be a specific width, but it should form a continuous loop around both inputs. For further reduction of leakage currents, components can be mounted to the PC board using Teflon standoff insulators.


FIGURE 41. GUARD RING EXAMPLE FOR UNITY GAIN AMPLIFIER

## Current Limiting

These devices have no internal current-limiting circuitry. If the output is shorted, it is possible to exceed the Absolute Maximum Rating for output current or power dissipation, potentially resulting in the destruction of the device.

## Power Dissipation

It is possible to exceed the $+150^{\circ} \mathrm{C}$ maximum junction temperatures under certain load and power-supply conditions. It is therefore important to calculate the maximum junction temperature ( $\mathrm{T}_{\mathrm{JMAX}}$ ) for all applications to determine if power supply voltages, load conditions, or package type need to be modified to remain in the safe operating area. These parameters are related in Equation 1:
$\mathrm{T}_{\text {JMAX }}=\mathrm{T}_{\text {MAX }}+\left(\theta_{\text {JA }} \times\right.$ PD $\left._{\text {MAXTOTAL }}\right)$
where:

- PDMAXTOTAL is the sum of the maximum power dissipation of each amplifier in the package ( $\mathrm{PD}_{\mathrm{MAX}}$ )
- $P D_{\text {MAX }}$ for each amplifier can be calculated as shown in Equation 2:
$P D_{\text {MAX }}=2 * V_{S} \times I_{\text {SMAX }}+\left(V_{S}-V_{\text {OUTMAX }}\right) \times \frac{V_{\text {OUTMAX }}}{R_{L}}$ (EQ. 2)
where:
- $\mathrm{T}_{\text {MAX }}=$ Maximum ambient temperature
- $\theta_{\mathrm{JA}}=$ Thermal resistance of the package
- $\mathrm{PD}_{\mathrm{MAX}}=$ Maximum power dissipation of 1 amplifier
- $\mathrm{V}_{\mathrm{S}}=$ Supply voltage (Magnitude of $\mathrm{V}_{+}$and $\mathrm{V}_{-}$)
- $I_{\text {MAX }}=$ Maximum supply current of 1 amplifier
- $\mathrm{V}_{\text {OUtmAX }}=$ Maximum output voltage swing of the application
- $\mathrm{R}_{\mathrm{L}}=$ Load resistance


## Package Outline Drawing

## P6.064A

6 LEAD SMALL OUTLINE TRANSISTOR PLASTIC PACKAGE Rev 0, 2/10


TYPICAL RECOMMENDED LAND PATTERN

$\underline{\underline{\text { END VIEW }}}$


NOTES:

1. Dimensions are in millimeters.

Dimensions in ( ) for Reference Only.
2. Dimensioning and tolerancing conform to ASME Y14.5M-1994.
3. Dimension is exclusive of mold flash, protrusions or gate burrs.
4. Foot length is measured at reference to guage plane.
5. This dimension is measured at Datum " H ".
6. Package conforms to JEDEC MO-178AA.

## Package Outline Drawing

M8.15E
8 LEAD NARROW BODY SMALL OUTLINE PLASTIC PACKAGE Rev 0, 08/09



TYPICAL RECOMMENDED LAND PATTERN


DETAIL "A"

NOTES:

1. Dimensions are in millimeters. Dimensions in ( ) for Reference Only.
2. Dimensioning and tolerancing conform to AMSE Y14.5m-1994.
3. Unless otherwise specified, tolerance : Decimal $\pm 0.05$
4. Dimension does not include interlead flash or protrusions. Interlead flash or protrusions shall not exceed 0.25 mm per side.
5. The pin \#1 identifier may be either a mold or mark feature.
6. Reference to JEDEC MS-012.

## Package Outline Drawing

M8.118A
8 LEAD MINI SMALL OUTLINE PLASTIC PACKAGE (MSOP) Rev 0, 9/09


TOP VIEW


SIDE VIEW 1


TYPICAL RECOMMENDED LAND PATTERN


DETAIL "X"

NOTES:

1. Dimensions are in millimeters.
2. Dimensioning and tolerancing conform to JEDEC MO-187-AA and AMSE Y14.5m-1994.
3. Plastic or metal protrusions of $\mathbf{0 . 1 5 m m}$ max per side are not included.
4. Plastic interlead protrusions of 0.25 mm max per side are not included.
5. Dimensions "D" and "E1" are measured at Datum Plane "H".
6. This replaces existing drawing \# MDP0043 MSOP 8L.

## Thin Shrink Small Outline Plastic Packages (TSSOP)



NOTES:

1. These package dimensions are within allowable dimensions of JEDEC MO-153-AC, Issue E.
2. Dimensioning and tolerancing per ANSI Y14.5M-1982.
3. Dimension " $D$ " does not include mold flash, protrusions or gate burrs. Mold flash, protrusion and gate burrs shall not exceed 0.15 mm (0.006 inch) per side.
4. Dimension "E1" does not include interlead flash or protrusions. Interlead flash and protrusions shall not exceed 0.15 mm ( 0.006 inch) per side.
5. The chamfer on the body is optional. If it is not present, a visual index feature must be located within the crosshatched area.
6. " $L$ " is the length of terminal for soldering to a substrate.
7. " N " is the number of terminal positions.
8. Terminal numbers are shown for reference only.
9. Dimension "b" does not include dambar protrusion. Allowable dambar protrusion shall be 0.08 mm ( 0.003 inch) total in excess of "b" dimension at maximum material condition. Minimum space between protrusion and adjacent lead is 0.07 mm ( 0.0027 inch ).
10. Controlling dimension: MILLIMETER. Converted inch dimensions are not necessarily exact. (Angles in degrees)

M14.173
14 LEAD THIN SHRINK SMALL OUTLINE PLASTIC PACKAGE

| SYMBOL | INCHES |  | MILLIMETERS |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | MIN | MAX | MIN | MAX |  |
| A | - | 0.047 | - | 1.20 | - |
| A1 | 0.002 | 0.006 | 0.05 | 0.15 | - |
| A2 | 0.031 | 0.041 | 0.80 | 1.05 | - |
| b | 0.0075 | 0.0118 | 0.19 | 0.30 | 9 |
| c | 0.0035 | 0.0079 | 0.09 | 0.20 | - |
| D | 0.195 | 0.199 | 4.95 | 5.05 | 3 |
| E1 | 0.169 | 0.177 | 4.30 | 4.50 | 4 |
| e | 0.026 |  | BSC | 0.65 |  |
| ESC | - |  |  |  |  |
| L | 0.246 | 0.256 | 6.25 | 6.50 | - |
| N | 0.0177 | 0.0295 | 0.45 | 0.75 | 6 |
| $\alpha$ | 14 |  |  | $0^{0}$ | $8^{0}$ |

Rev. 2 4/06

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